2SD2000

Silicon NPN triple diffusion planar type

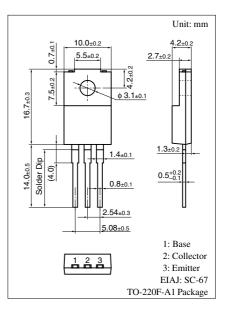
For power switching

Features

- High-speed switching
- \bullet Satisfactory linearity of forward current transfer ratio h_{FE}
- Large collector power dissipation P_C
- Full-pack package which can be installed to the heat sink with one screw

Parameter		Symbol	Rating	Unit			
Collector to base voltage		V _{CBO}	80	V			
Collector to emitter voltage		V _{CEO}	60	V			
Emitter to base voltage		V _{EBO}	6	V			
Peak collector current		I _{CP}	8	А			
Collector current		I _C	4	А			
Base current		IB	1	А			
Collector power	$T_C = 25^{\circ}C$	P _C	35	W			
dissipation	$T_a = 25^{\circ}C$		2				
Junction temperature		Tj	150	°C			
Storage temperature		T _{stg}	-55 to +150	°C			

Absolute Maximum Ratings $T_C = 25^{\circ}C$

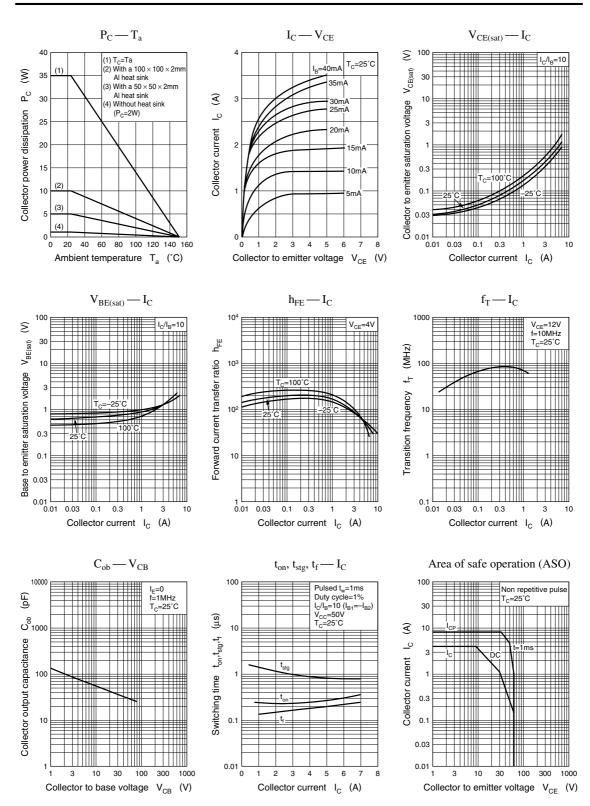


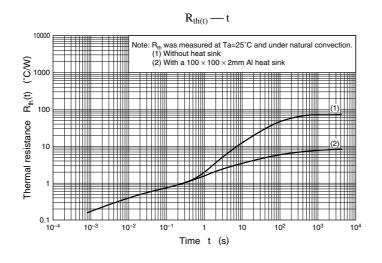
Electrical Characteristics $T_C = 25^{\circ}C$

Parameter	Symbol	Conditions	Min	Тур	Мах	Unit
Collector cutoff current	I _{CBO}	$V_{CB} = 80 V, I_E = 0$			100	μΑ
Emitter to base current	I _{EBO}	$V_{EB} = 6 V, I_C = 0$			100	μΑ
Collector to emitter voltage	V _{CEO}	$I_{\rm C} = 25 \text{ mA}, I_{\rm B} = 0$	60			V
Forward current transfer ratio	h _{FE1} *	$V_{CE} = 4 V, I_C = 1 A$	70		250	
	h _{FE2}	$V_{CE} = 4 V, I_C = 4 A$	20			
Base to emitter saturation voltage	V _{BE(sat)}	$V_{CE} = 4 V, I_C = 4 A$			2.0	V
Collector to emitter saturation voltage	V _{CE(sat)}	$I_{\rm C} = 4 {\rm A}, I_{\rm B} = 0.4 {\rm A}$			1.5	V
Transition frequency	\mathbf{f}_{T}	$V_{CE} = 12 \text{ V}, I_C = 0.2 \text{ A}, f = 10 \text{ MHz}$		80		MHz
Turn-on time	t _{on}	$I_C = 4 A, I_{B1} = 0.4 A, I_{B2} = -0.4 A,$		0.3		μs
Storage time	t _{stg}	$V_{CC} = 50 \text{ V}$		1.0		μs
Fall time	t _f			0.2		μs

Note) *: Rank classification

Rank	Q	Р		
h _{FE1}	70 to 150	120 to 250		





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